



CPC1135N 350V Normally-Closed Single-Pole 4-Pin SOP OptoMOS[®] Relay

Parameter	Rating	Units
Blocking Voltage	350	V _P
Load Current	120	mA _{rms} / mA _{DC}
On-Resistance (max)	35	Ω

Features

- 1500V_{rms} Input/Output Isolation
 Low Drive Power Requirements
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 4-Pin SOP Package
- Tape & Reel Version Available
- Flammability Rating UL 94 V-0

Applications

- Telecommunications
- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Hook Switch
- Dial Pulsing
- · Ground Start
- Ringing Injection
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The CPC1135N is a miniature, normally-closed, single-pole (1-Form-B) solid state relay that uses optically coupled MOSFET technology to provide 1500V_{rms} of input to output isolation.

Its optically coupled output, which uses the patented OptoMOS architecture, is controlled by a highly efficient infrared LED.

IXYS Integrated Circuits' state of the art doublemolded vertical construction packaging enables the CPC1135N to be one of the world's smallest 4-pin solid state relays. It offers board space savings over the competitor's larger 4-pin SOP relay.

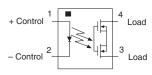
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component: Certificate available on our website

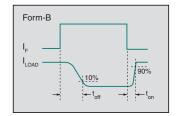
Ordering Information

Part #	Description
CPC1135N	4-Pin SOP (100/tube)
CPC1135NTR	4-Pin SOP (2000/reel)

Pin Configuration



Switching Characteristics of Normally-Closed Devices







Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing

Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	350	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	А
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	400	mW
Capacitance, Input to Output	1	pF
Isolation Voltage, Input to Output	1500	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

² Derate linearly 3.33 mW / °C

Ele

Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics			·			·
Load Current						
Continuous ¹	-	Ι _L	-	-	120	mA _{rms} / mA _{DC}
Peak	t =10ms	I _{LPK}	-	-	±350	mA _P
On-Resistance ²	I _L =120mA	R _{on}	-	-	35	Ω
Off-State Leakage Current	I _F =2mA, V _L =350V _P	I _{LEAK}	-	-	5	μΑ
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	t _{on}	-	-	2	ms
Turn-Off		t _{off}	-	-	2	1115
Output Capacitance	I _F =2mA, V _L =50V, f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics						
Input Control Current to Activate ³	I _L =120mA	I _F	-	0.6	2	mA
nput Control Current to Deactivate	-	I _F	0.3	0.55	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.5	V
Reverse Input Current	V _B =5V	I _R	-	-	10	μΑ

not implied.

testing requirements.

Load current derates linearly from 120mA @ 25°C to 80mA @ 85°C.

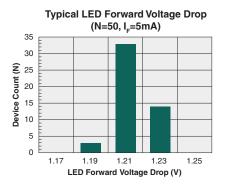
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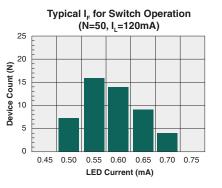
Measurement taken within 1 second of on-time. For applications requiring high temperature operation (greater than 60°C) a minimum LED drive current of 4mA is recomended. 3

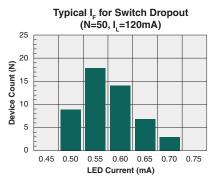


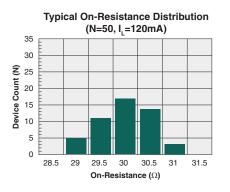
CPC1135N

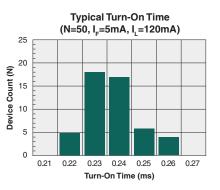


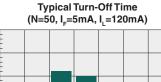




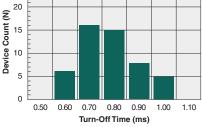


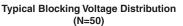


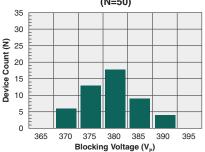


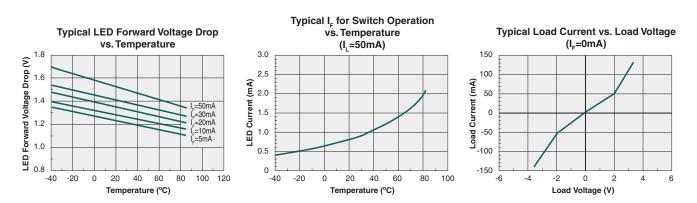


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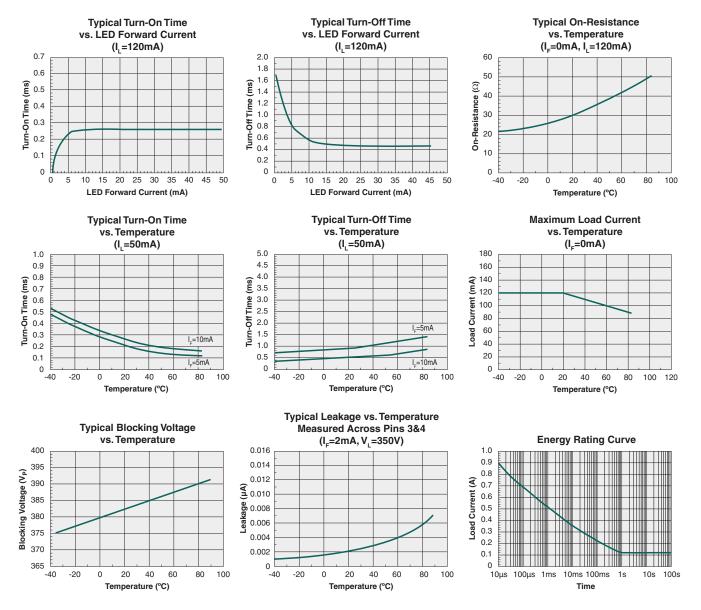


*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.



CPC1135N

PERFORMANCE DATA*



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Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
CPC1135N	MSL 3

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Soldering Profile

Provided in the table below is the Classification Temperature (T_c) of this product and the maximum dwell time the body temperature of this device may be $(T_c - 5)^{\circ}C$ or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

Device	Classification Temperature (T _c)	Dwell Time (t _p)	Max Reflow Cycles
CPC1135N	260°C	30 seconds	3

Board Wash

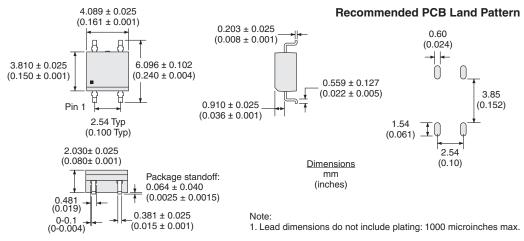
IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.



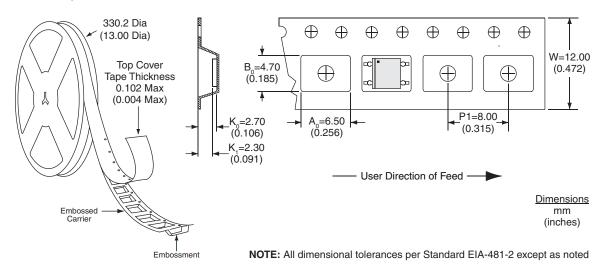


Mechanical Dimensions





CPC1135NTR Tape & Reel



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